

Ultra Low Profile 0805 Balun 50Ω to 100Ω Balanced





Description:

The BD2040J50100AHF is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering multiple ISM bands. The BD2040J50100AHF is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD2040J50100AHF has an unbalanced port impedance of 50 Ω and a 100 Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD2040J50100AHF is available on tape and reel for pick and place high volume manufacturing.

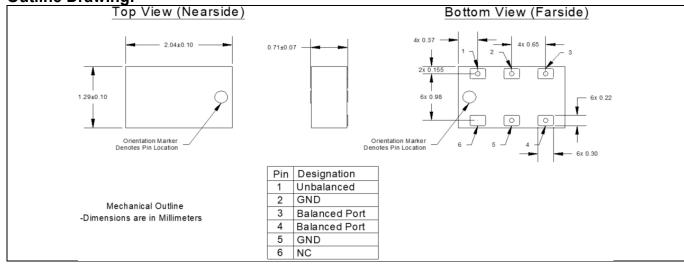
Detailed Electrical Specifications:

Specifications subject to change without notice

		ROOM (25°C)						
<u>Features:</u>	Parameter	Min.	Тур.	Мах	Min.	Тур.	Max	Unit
• 2000 – 4000 MHz	Frequency	2650		3500	2000		4000	MHz
 0.7mm Height Profile 50 Ohm to 2 x 50 Ohm 	Unbalanced Port Impedance		50			50		Ω
 Multiple ISM bands 	Balanced Port Impedance		100			100		Ω
Low Insertion Loss	Return Loss	13.0	16.9		10	14.2		dB
Input to Output DC	Insertion Loss*		0.8	1.0		1.06	1.3	dB
Isolation	Amplitude Balance		0.6	1.3		0.8	1.48	dB
 Surface Mountable Tape & Reel 	Phase Balance		8.2	13.0		15	16.5	Degrees
 Tape & Reel Non-conductive 	CMRR		21.7			17		dB
Surface	Power Handling @85C			2			2	Watts
RoHS Compliant	Power Handling @105C			1.2			1.2	Watts
Halogen Free	Operating Temperature	-55		+140	-55		+140	°C

*Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

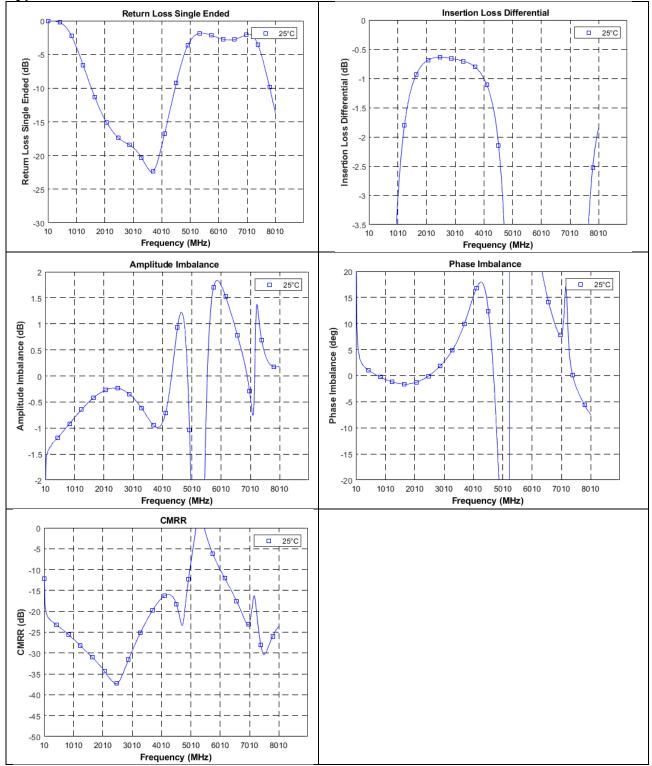
Outline Drawing:



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Typical Performance: 10 MHz to 8010 MHz

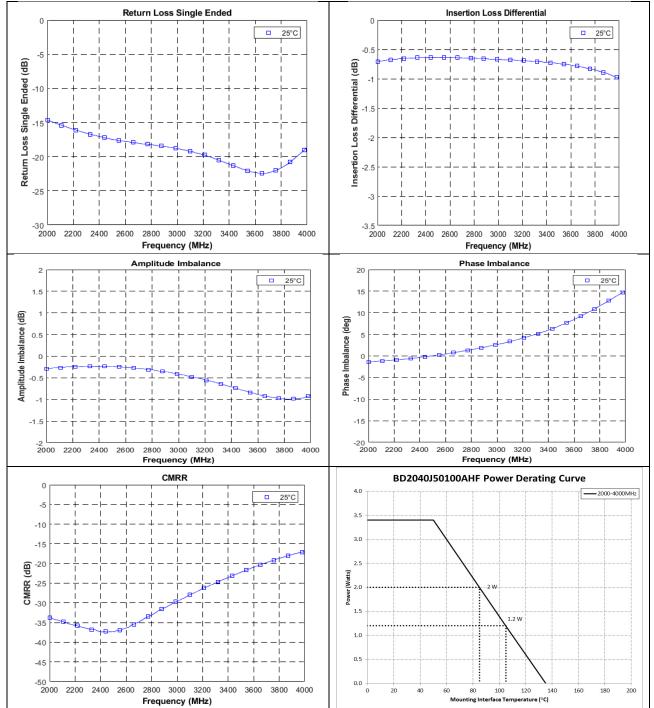


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Wide Band Performance: 2000 MHz to 4000 MHz



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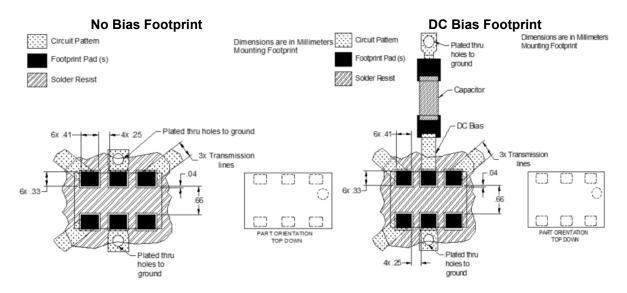


Mounting Configuration:

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

All of the Xinger components are constructed from organic PTFE based composites which possess excellent electrical and mechanical stability. Xinger components are compliant to a variety of ROHS and Green standards and ready for Pb-free soldering processes. Pads are Gold plated with a Nickel barrier.

An example of the PCB footprint used in the testing of these parts is shown on the next page. An example of a DC-biased footprint is also shown on the next page. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.

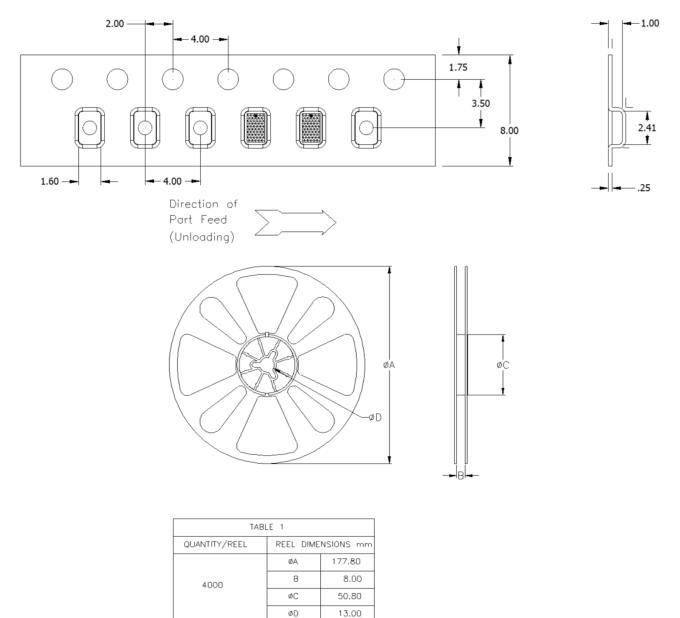


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Packaging and Ordering Information:

Parts are available in reel and are packaged per EIA 481-D. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel.



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